

UNISONIC TECHNOLOGIES CO., LTD

3NM50 Preliminary Power MOSFET

3.0A, 500V N-CHANNEL SUPER-JUNCTION MOSFET

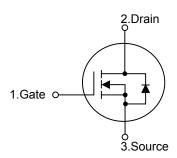
■ DESCRIPTION

The **UTC 3NM50** is a Super Junction MOSFET Structure and is designed to have better characteristics, such as fast switching time, low gate charge, low on-state resistance and a high rugged avalanche characteristics. This power MOSFET is usually used at DC-DC, AC-DC converters for power applications.

■ FEATURES

- * $R_{DS(ON)}$ < 1.8 Ω @ V_{GS} =10V, I_{D} =1.5A
- * High Switching Speed
- * 100% Avalanche Tested

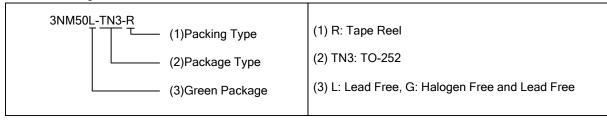
■ SYMBOL

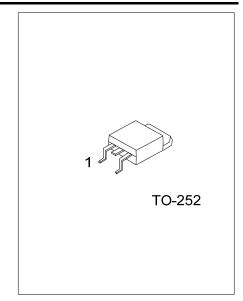


■ ORDERING INFORMATION

Ordering Number		Deelvere	Pin Assignment			Dooking	
Lead Free	Halogen Free	Package	1	2	3	Packing	
3NM50L-TN3-R	3NM50G-TN3-R	TO-252	G	D	S	Tape Reel	

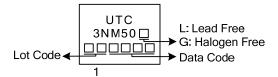
Note: Pin Assignment: G: Gate D: Drain S: Source





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MARKING



■ ABSOLUTE MAXIMUM RATINGS (T_C=25°C, unless otherwise specified)

PARAMETER		SYMBOL	RATINGS	UNIT
Drain-Source Voltage		V_{DSS}	500	V
Gate-Source Voltage		V_{GSS}	±30	V
Drain Current (T _C =25°C)	Continuous	I _D	3.0	Α
	Pulsed (Note 2)	I _{DM}	12	Α
Avalanche Current (Note 2)		I _{AR}	2.4	Α
Avalanche Energy (Note 3)	Single Pulsed	E _{AS}	29	mJ
Peak Diode Recovery dv/dt (Note 4)		dv/dt	5.3	V/ns
Power Dissipation		P_{D}	50	W
Junction Temperature		T_J	+150	°C
Storage Temperature		T _{STG}	-55 ~ +150	°C

- Notes: 1. Absolute maximum ratings are those values beyond which the device could be permanently damaged.

 Absolute maximum ratings are stress ratings only and functional device operation is not implied.
 - 2. Repetitive Rating: Pulse width limited by maximum junction temperature.
 - 3. L=10mH, I_{AS} =2.4A, V_{DD} =50V, R_{G} =25 Ω , Starting T_{J} = 25°C.
 - 4. $I_{SD} \le 3.0A$, di/dt $\le 200A/\mu s$, $V_{DD} \le BV_{DSS}$, Starting $T_J = 25$ °C.

■ THERMAL DATA

PARAMETER	SYMBOL	RATINGS	UNIT	
Junction to Ambient	θ_{JA}	110	°C/W	
Junction to Case	θ_{JC}	2.5	°C/W	

■ ELECTRICAL CHARACTERISTICS (T_J=25°C, unless otherwise noted)

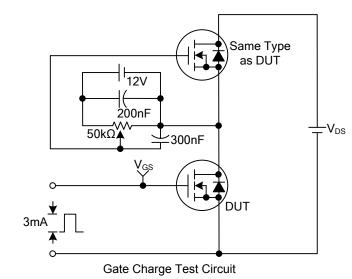
PARAMETER		SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT	
OFF CHARACTERISTICS								
Drain-Source Breakdown Voltage		BV _{DSS}	I _D =250μA, V _{GS} =0V	500			V	
Drain-Source Leakage Current		I _{DSS}	V _{DS} =500V, V _{GS} =0V			10	μΑ	
Gate- Source Leakage Current	Forward	I _{GSS}	V_{GS} =+30V, V_{DS} =0V			+100	nA	
	Reverse		V_{GS} =-30V, V_{DS} =0V			-100	nA	
ON CHARACTERISTICS								
Gate Threshold Voltage		$V_{GS(TH)}$	$V_{DS}=V_{GS}$, $I_{D}=250\mu A$	2.5		4.5	V	
Static Drain-Source On-State Resistance		R _{DS(ON)}	V _{GS} =10V, I _D =1.5A			1.8	Ω	
DYNAMIC PARAMETERS								
Input Capacitance		C _{ISS}	\\ -0\\ \\ -25\\		155		pF	
Output Capacitance		Coss	V _{GS} =0V, V _{DS} =25V, -f=1.0MHz		137		pF	
Reverse Transfer Capacitance		C_{RSS}	1-1:000112		25		pF	
SWITCHING PARAMETERS								
Total Gate Charge (Note 1)	Total Gate Charge (Note 1)		V _{DS} =50V, V _{GS} =10V, I _D =1.3A,		35		nC	
Gate to Source Charge		Q_GS	$I_{G} = 250 \mu A \text{ (Note 1, 2)}$		3		nC	
Gate to Drain Charge		Q_GD	IG - 230μΑ (Note 1, 2)		7.5		nC	
Turn-ON Delay Time (Note 1)		$t_{D(ON)}$	\/ -20\/ \/ -40\/		37		ns	
Rise Time		t_R	V _{DD} =30V, V _{GS} =10V, I _D =0.5A,		37		ns	
Turn-OFF Delay Time		t _{D(OFF)}	-0.5A, -R _G =25Ω (Note 1, 2)		82		ns	
Fall-Time		t_{F}	NG-2312 (Note 1, 2)		44		ns	
SOURCE- DRAIN DIODE RATINGS AND CHARACTERISTICS								
Maximum Body-Diode Continuo	us Current	I_S				3	Α	
Maximum Body-Diode Pulsed Current		I _{SM}				12	Α	
Drain-Source Diode Forward Voltage (Note 1)		V_{SD}	I _S =3.0A, V _{GS} =0V			1.4	V	
Reverse Recovery Time (Note 1)		t _{rr}	I _S =3.0A, V _{GS} =0V,		210		ns	
Reverse Recovery Charge		Q _{rr}	dI _F /dt = 100A/μs		1.2		μC	

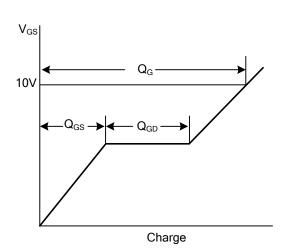
Notes: 1. Pulse Test: Pulse width ≤ 300µs, Duty cycle ≤ 2%.

2. Essentially independent of operating temperature.

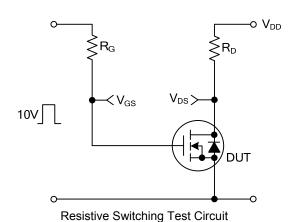


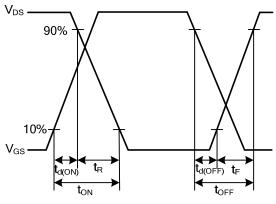
■ TEST CIRCUITS AND WAVEFORMS



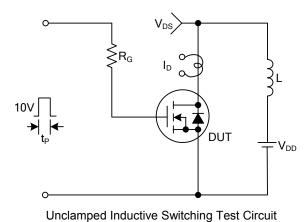


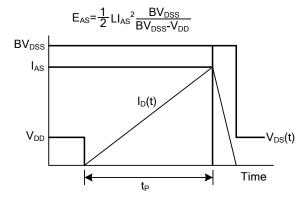
Gate Charge Waveforms





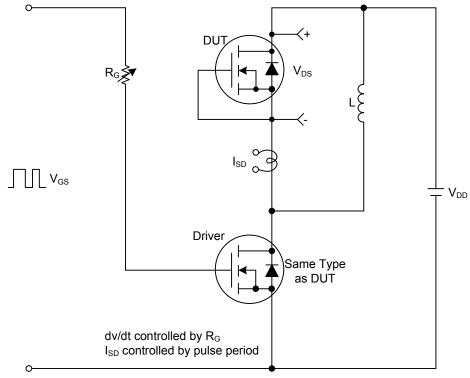
Resistive Switching Waveforms



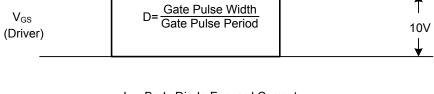


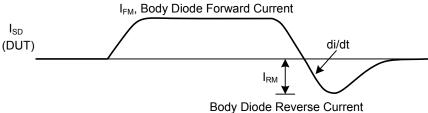
Unclamped Inductive Switching Waveforms

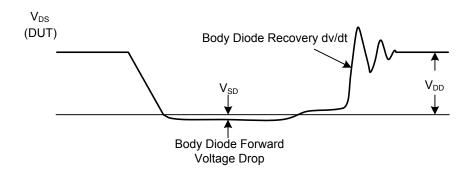
■ TEST CIRCUITS AND WAVEFORMS(Cont.)



Peak Diode Recovery dv/dt Test Circuit & Waveforms







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